



## DESCRIPTION

The DB101S~DB107S are available in DBS package.

## FEATURES

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High temperature soldering guaranteed: 250\*/10 seconds / 0.375"(9.5mm) led length at 5 lbs., (2.3kg)tension
- Small size, simple installation Leads solderable per MIL-STD-202, Method 208
- High surge current capability
- Available in DBS package

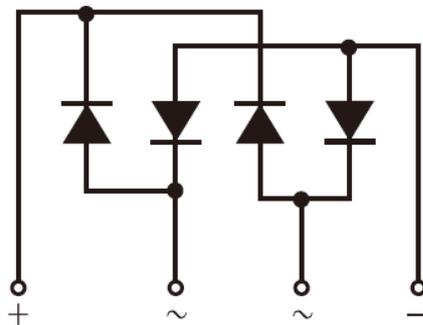
## ORDERING INFORMATION

Package Type	Part Number
DBS	DB101S
	DB102S
	DB103S
	DB104S
	DB105S
	DB106S
	DB107S
Note	SPQ: 1,500pcs/Reel
AiT provides all RoHS Compliant Products	

## MECHANICAL DATA

- Case: Molded plastic body
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026
- Polarity: Polarity symbols marked on case
- Mounting Position: Any
- Weight:0.02 ounce, 0.4 grams

## PIN DESCRIPTION





## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, For capacitive load derate current by 20%.

Parameter	Symbol	DB101S	DB102S	DB103S	DB104S	DB105S	DB106S	DB107S	Unit
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_A=40^\circ\text{C}$	$I_{F(AV)}$	1.0							A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	50							A
Maximum instantaneous forward voltage Drop per Bridge Element at 1.0A	$V_F$	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	$T_A=25^\circ\text{C}$	10 500							$\mu\text{A}$
	$T_A=125^\circ\text{C}$								
Operating Temperature Range	$T_J$	-55~150							$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55~150							$^\circ\text{C}$

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

NOTES: DBS for surface mount package.



## TYPICAL PERFORMANCE CHARACTERISTICS

Figure 1. Maximum Derating Curve for Output Rectified Current

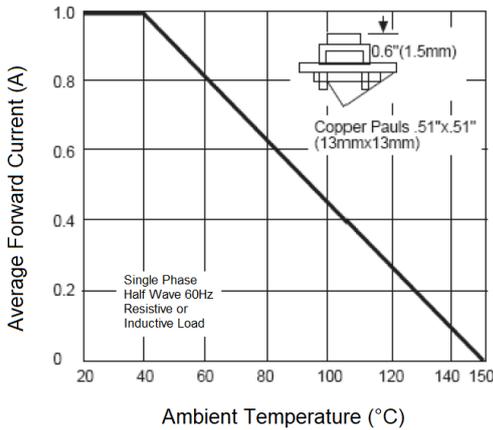


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

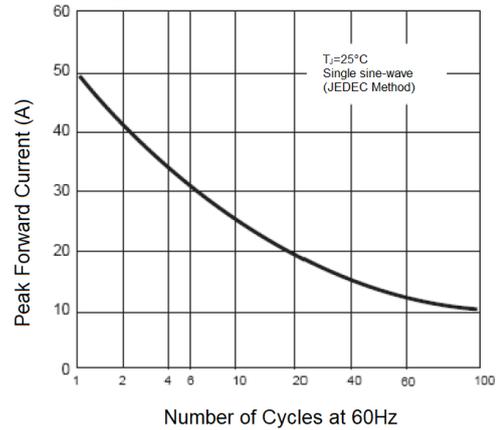


Figure 3. Typical Reverse Characteristics Per Bridge Element

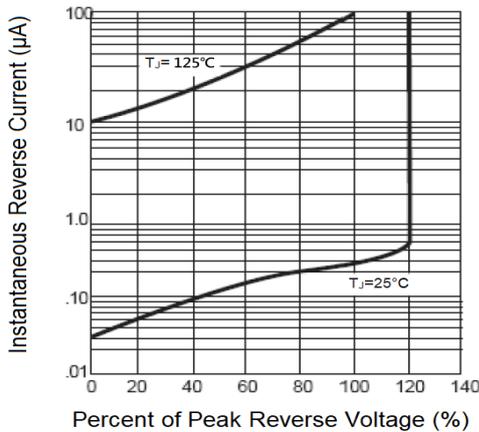


Figure 4. Typical Forward Characteristics Per Bridge Element

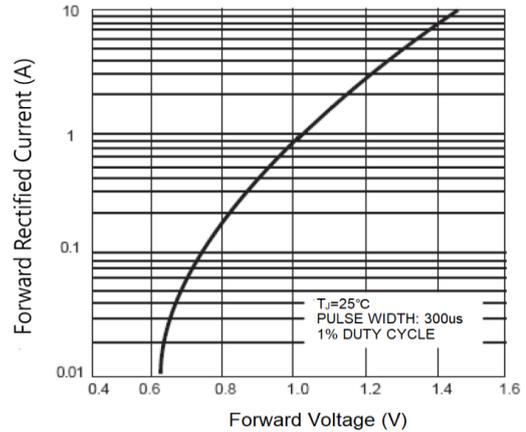
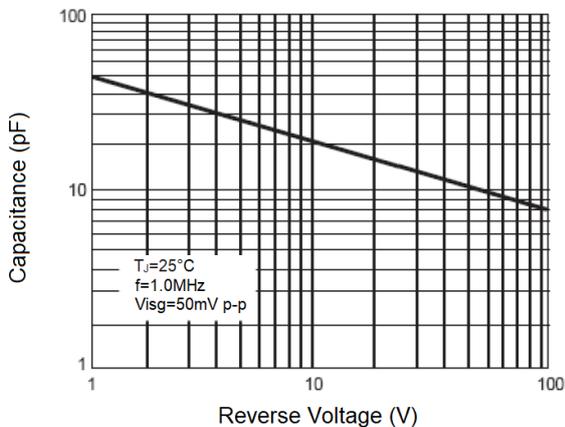


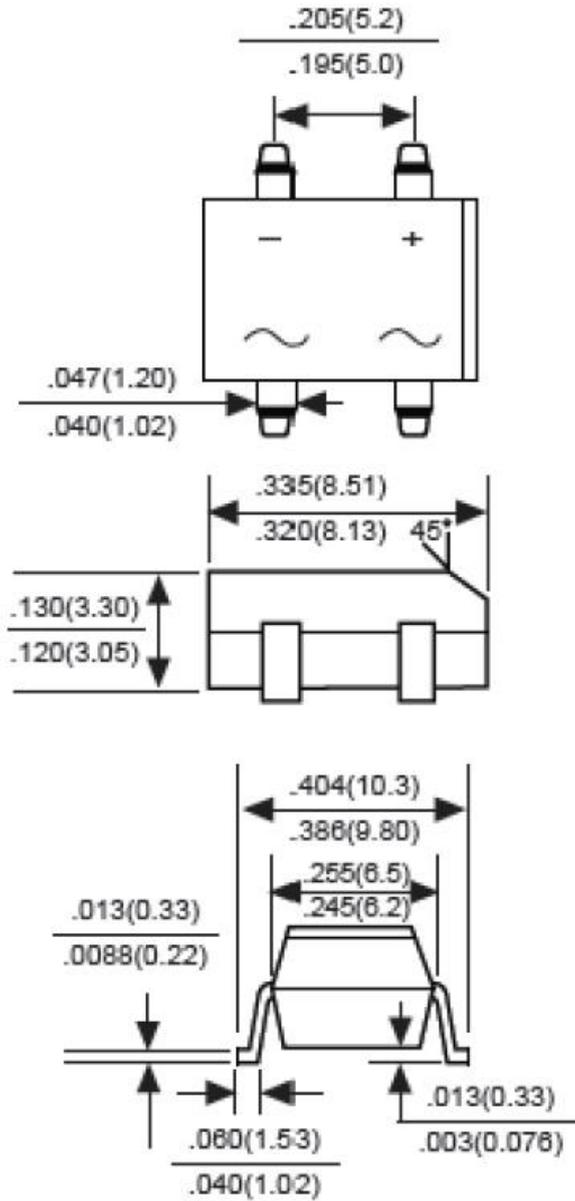
Figure 5. Typical Junction Capacitance Per Bridge Element





**PACKAGE INFORMATION**

Dimension in DBS Package (Unit: inches(mm))





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